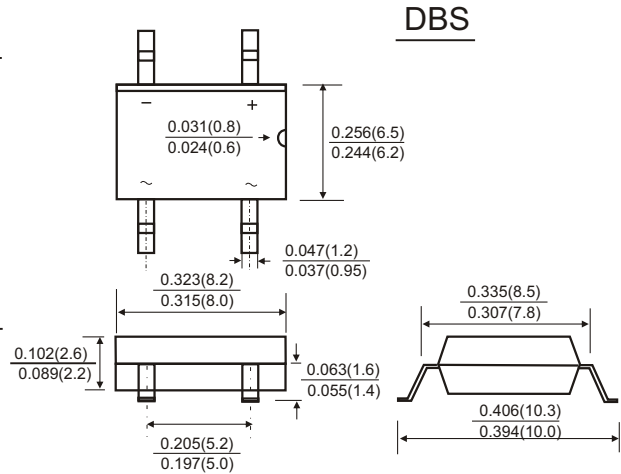


## FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- Rating to 1000V PRV
- Ideal for printed circuit board
- High temperature soldering guaranteed: 260 °C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

## MECHANICAL DATA

- Case: DBS molded plastic body
- Epoxy: UL94V-0 rate flame retardant
- Terminals: Plated leads solderable per MIL-STD-750, method 2026
- Mounting Position: Any
- Weight: 0.02ounce, 0.38 gram



Dimensions in inches and (millimeters)

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.)

	Symbols	DB201S	DB202S	DB203S	DB204S	DB205S	DB206S	DB207S	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current	I <sub>(AV)</sub>	2.0							Amp
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	60							Amps
Maximum Instantaneous Forward Voltage at I <sub>F</sub> = 0 A DC	V <sub>F</sub>	1.1							Volts
Maximum DC Reverse Current at rated DC blocking voltage	T <sub>A</sub> = 25 °C	10							μA
	T <sub>A</sub> = 125 °C	500							
Typical junction capacitance(Note 1)	C <sub>J</sub>	25							pF
Typical thermal resistance(Note 2)	R <sub>θJA</sub>	40							K/W
Operating junction and storage temperature range	T <sub>J</sub> T <sub>STG</sub>	-55 to +150							°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0 Volts.

2. Thermal resistance junction to ambient mounted on P.C.B. With 05\*0.5 inches(1.3\*1.3mm) copper pads

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

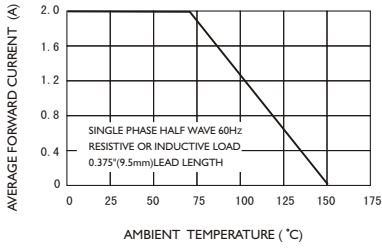


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

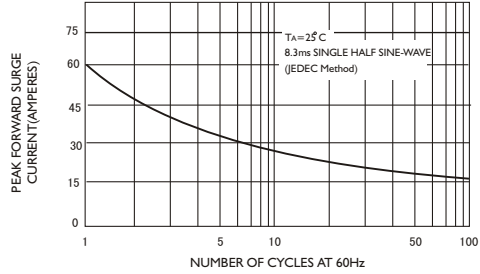


FIG3-TYPICAL JUNCTION CAPACITANCE

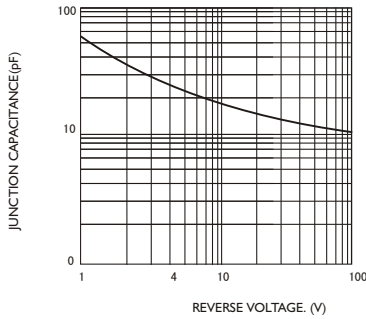


FIG4-TYPICAL FORWARD CHARACTERISTICS

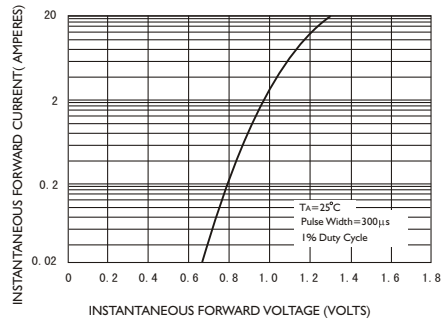


FIG.5-TYPICAL REVERSE CHARACTERISTICS

